

Soliton Devices, Inc.

SPECIFICATIONS

FS-2002A DR11787

MAXIMUM RATINGS

Voltage, Collector to Base (V_{CB0})	-350	V
Voltage, Collector to Emitter (V_{CEO})	-300	V
Voltage, Emitter to Base (V_{EBO})	-6.0	V
Collector Current (I_C)	-1.0	A
Base Current (I_B)	-500	mA
Maximum Thermal Resistance, Junction to Case	17.5	°C/W
Maximum Junction Temperature	-55°C TO 200	°C
Power of Transistor (P_T) $T_C = 100^\circ\text{C}$	5.7	WATTS
Power of Dissipation (P_t) $T_c=25^\circ\text{C}$	12	WATTS

TA = 25°C		PERFORMANCE CHARACTERISTICS		UNLESS OTHERWISE NOTED		
NO.	SYMBOL	CONDITIONS		MIN.	MAX.	UNITS
1	I-CEO	$V_{CE} = -250\text{ V}$	$I_B = 0$		-50	µA
2	I-CBO	$V_{CB} = -280\text{ V}$	$I_B = 0$		-50	µA
3	I-CEV	$V_{CE} = -300\text{ V}$	$V_{BE} = 1.5\text{ V}$		-50	µA
4	I-EBO	$V_{EB} = -6.0\text{ V}$	$I_C = 0$		-20	µA
5	h-FE *	$V_{CE} = -10\text{ V}$	$I_C = -50\text{ mA}$	30	120	
6	V-CEO (sus)	$I_C = -50\text{ mA}$	$I_B = 0$	-300		V
7	V-CER (sus)	$I_C = -50\text{ mA}$	$R = 50\ \Omega$	-350		V
8	V-BE (ON) *	$V_{CE} = -10\text{ V}$	$I_C = -50\text{ mA}$		-1.5	V
9	V-CE (S) *	$I_C = -50\text{ mA}$	$I_B = 5.0\text{ mA}$		-2.0	V
10	h-FE	$V_{CE} = -10\text{ V}$	$I_C = -5.0\text{ mA}$ $f = 1.0\text{ KHz}$	25		
11	h-FE	$V_{CE} = -10\text{ V}$	$I_C = -10\text{ mA}$ $f = 5.0\text{ MHz}$	3.0		
12	R_{hie}	$V_{CE} = -10\text{ V}$	$I_C = -5.0\text{ mA}$ $f = 1.0\text{ MHz}$		300	Ω
13	Cibo	$V_{EB} = -5.0\text{ V}$	$I_C = 0$ $f = 1.0\text{ MHz}$		75	PF
14	C-obo	$V_{CB} = -10\text{ V}$	$I_E = 0$ $f = 1.0\text{ MHz}$		15	PF
15	IS/b	$V_{CE} = -100\text{ V}$		-100		mA
16	θ-JC				17.5	°C/W
17						
18						
19						
20						

NOTES: *PULSED: 300 USEC; D.C. = 2.0%
 WRITTEN TO JEDEC 5781 AND SOLITRON
 CAT 12-74-EE.
 * JEDEC REGISTERED PARAMETER.

MARK: -S-
 2N5416
 DATE CODE

EXCEPTION TO
 JEDEC TO-5 CASE

12-12-77 - REWRITTEN, DELETED STATEMENT
 LINE 10, ADDED TEST #1, 3. M.W.
 REV "A" - ADDED THREE DIGIT (EDP CODE). DELETED PULSE TESTS.
 LINE 8 - WAS V-BE(S) - CASE EXCEPTION ADDED.
 10/7/81 62

Customer: GENERAL PURPOSE
 DATE 12-12-77 M.W.

EEEQ5416
 EDP CODE: 200EQC5416
 NO.: 2N5416
 TYPE: PNP SILICON POWER
 CASE: TO-39 #

SOLITRON DEVICES, INC. PRODUCT SPECIFICATION

SOLITRON P/N: 2N4416 CUSTOMER P/N: _____ REV: _____

ORIGINATOR: MILITARY REFERENCE SPEC: _____ REV: _____

PKG: TO-72
 PARTS DWG: DR15014
 EDS NO:
 DESIGN LIMITS: FN2.5
 REFERENCE DEVICE: JEDEC RELEASE NO. 5383

DEVICE MARKING

- (a) S
- (b) 2N4416
- (c) DATE CODE
- (d) ESD SYMBOL (Δ)
- (e)

CONTROLLED
DOCUMENT

PACKAGING:

PACKAGE MARKING

- (a) SOLITRON DEVICES INC.
- (b) CAGE/MFR 21845 P/N 2N4416
- (c) N-CHANNEL FET
- (d) QUANTITY EACH / DATE CODE
- (e) P.O. / CONTRACT NUMBER
- (f) MONTH/YEAR OF PACKING
- (g)
- (h)

SPECIFICATION REQUIREMENTS:

PRE CAP CSI _____

POLY-COAT _____

SCREENING _____

PIND TEST _____

GROUP A _____ X

GROUP B _____

GROUP C _____

SOLDER-DIP _____

X-RAY _____

FINAL CSI _____

DATA TO BE SUPPLIED:

C OF C _____ X

SUMMARIES _____

ATTRIBUTES TEST DATA _____

VARIABLES TEST DATA _____

GROUP B/C SAMPLES _____

X-RAY PLATES _____

APPROVAL SIGNATURES

PRODUCTION: Rajiv Sarda DATE: 2/7/00

ENGINEERING: [Signature] DATE: 2/7/00

QUALITY: [Signature] DATE: 2/10/00

DATE	REV.	RFC#	DESCRIPTION							
2/10/00	-	-	NEW RELEASE.							
		SPECIFICATION				ASSEMBLY				GROUP A
REV STATUS	REV	-	-	-	-	-	-	-	-	-
OF SHEETS	SH	1	2	3	4	5	6	7	8	9 10

ELECTRICAL CHARACTERISTICS

TYPE NO: 2N4416

[illegible]

SOLITRON DEVICES, INC. PRODUCT SPECIFICATION

SOLITRON P/N: FD1185 **CUSTOMER P/N:** A-1855-0049-1 **REV:** D
ORIGINATOR: HEWLETT PACKARD **REFERENCE SPEC:** A-5951-7600-1 **REV:** R
REFERENCE FILE: _____

PKG: TO-71
PARTS DWG: DR15002 OR DR15008
GEOMETRY: DFN. 3.6, DFN22.2
HEADER:810003 CAN:811001
REFERENCE DEVICE:

DEVICE MARKING

- (a) S
- (b) 5-049
- (c) DATE CODE
- (d) Δ
- (e)

PACKAGING:

PACKAGE MARKING

- (a) SOLITRON DEVICES INC.
- (b) CAGE/MFR 21845 P/N FD1185
- (c) P/N A-1855-0049-1
- (d) TRANSISTOR
- (e) QUANTITY EACH / DATE CODE
- (f) P.O./ CONTRACT NUMBER
- (g) MONTH/YEAR OF PACKING
- (h)

SPECIFICATION REQUIREMENTS:

PRE CAP CSI
 POLY-COAT
 SCREENING
 PIND TEST
 GROUP A X
 GROUP B
 GROUP C
 SOLDER-DIP
 X-RAY
 FINAL CSI

DATA TO BE SUPPLIED:

C OF C X
 SUMMARIES
 ATTRIBUTES TEST DATA ...
 VARIABLES TEST DATA
 GROUP B/C SAMPLES
 X-RAY PLATES

APPROVAL SIGNATURES

PRODUCTION:

[Signature]

DATE:

6/5/01

ENGINEERING:

[Signature]

DATE:

6/4/01

QUALITY:

[Signature]

DATE:

6/11/01

DATE	REV.	RFC#	DESCRIPTION
	E	H6787	UPDATED TO NEW FORMAT.

ELECTRICAL CHARACTERISTICS

TYPE NO: FD1185

[illegible]